TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSII^{.5})

2SK1359

DC-DC Converter and Motor Drive Applications

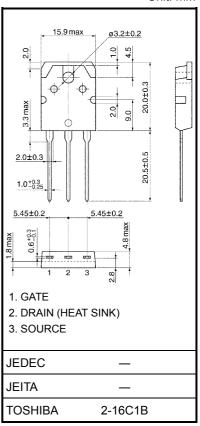
- Low drain-source ON resistance $: R_{DS} (ON) = 3.0 \Omega (typ.)$
- High forward transfer admittance $|Y_{fs}| = 2.0 \text{ S (typ.)}$
- Low leakage current $: I_{DSS} = 300 \ \mu A \ (max) \ (V_{DS} = 800 \ V)$
- Enhancement-mode : $V_{th} = 1.5 \sim 3.5 \text{ V} (V_{DS} = 10 \text{ V}, \text{I}_{D} = 1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	1000	V
Drain-gate voltage (R _{GS} = 20 kΩ)		V _{DGR}	1000	V
Gate-source voltage		V _{GSS}	±30	V
Drain current	DC (Note 1)	۱ _D	5	А
	Pulse (Note 1)	I _{DP}	15	A
Drain power dissipation (Tc = 25°C)		PD	125	W
Channel temperature		T _{ch}	150	°C
Storage temperature range		T _{stg}	-55~150	°C

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch−c)}	1.0	°C / W
Thermal resistance, channel to ambient	R _{th (ch−a)}	50	°C / W



Weight: 4.6 g (typ.)

Note 1: Please use devices on condition that the channel temperature is below 150°C.

This transistor is an electrostatic sensitive device. Please handle with caution. Unit: mm

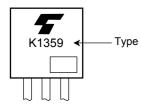
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±50	nA
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 800 V, V _{GS} = 0 V	_	_	300	μA
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	1000		—	V
Gate threshold v	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.5		3.5	V
Drain-source O	N resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 2 A	—	3.0	3.8	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = 20 V, I _D = 2 A	1.0	2.0	_	S
Input capacitance	ce	C _{iss}		_	700	—	pF
Reverse transfe	r capacitance	C _{rss}	V _{DS} = 25 V, V _{GS} = 0V, f = 1 MHz	_	55	_	
Output capacitance		Coss	1	_	100	—	
Rise	Rise time	tr	$V_{GS} \stackrel{10V}{\longrightarrow} I_{D} \stackrel{I_{D}=2A}{\longrightarrow} V_{OUT}$	_	18	_	
Switching time	Turn-on time	t _{on}	$\begin{array}{c c} VGS & _{OV} \end{bmatrix} \begin{bmatrix} & & \\$	_	30	_	20
	Fall time	t _f		_	12	_	ns
	Turn-off time	t _{off}	$V_{DD} \rightleftharpoons 400V$ Duty $\leq 1\%$, t _w =10 μ s	_	70	_	
Total gate charge (Gate-source plus gate-drain) Qg		Qg		_	60	_	nC
Gate-source charge		Q _{gs}	V _{DD} ≈ 400 V, V _{GS} = 10 V, I _D = 4 A	_	35	_	
Gate-drain ("miller") charge		Q _{gd}]		25	_	

Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	5	А
Pulse drain reverse current (Note 1)	I _{DRP}	—	_		15	A
Forward voltage (diode)	V _{DSF}	I _{DR} = 4 A, V _{GS} = 0 V	_	_	-1.9	V

Marking



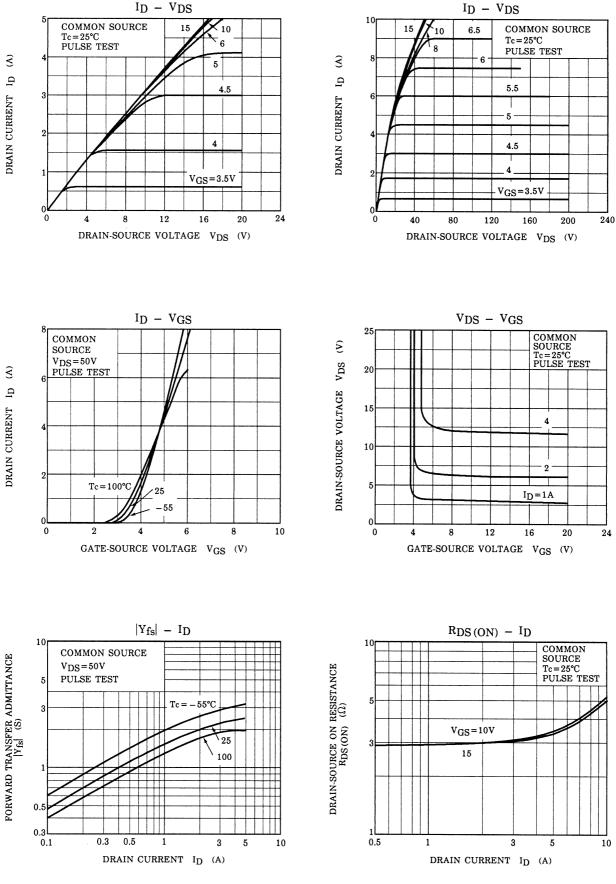
Lot Number

Month (starting from alphabet A)

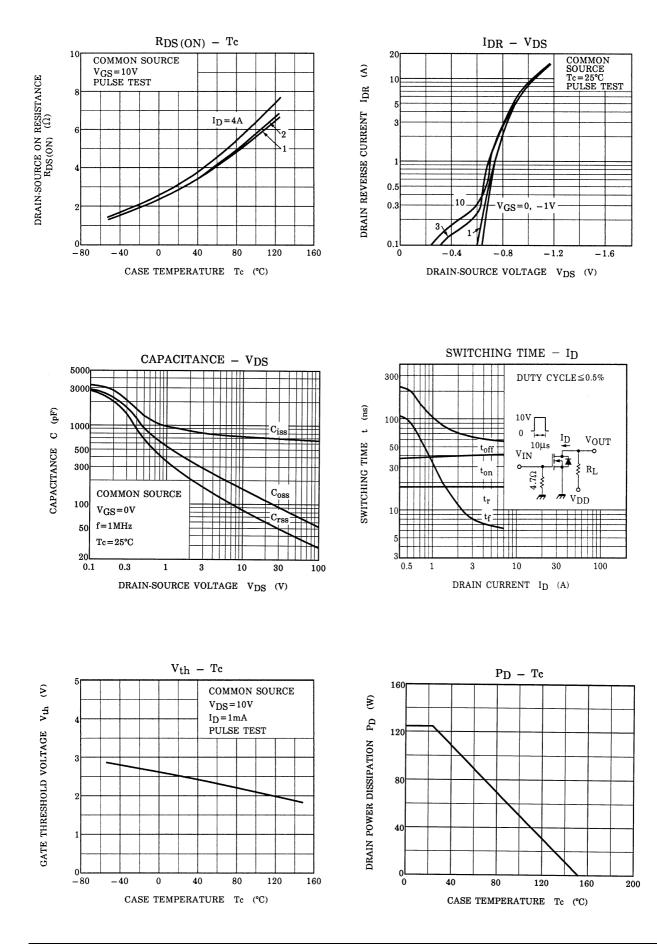
Year (last number of the christian era)

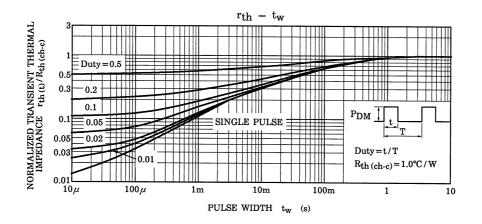
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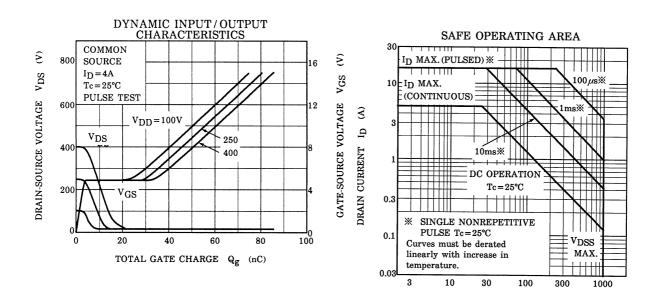
Ś ID DRAIN CURRENT



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DRAIN-SOURCE VOLTAGE V_{DS} (V)

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